



Technology-Mediated Agile Blended Learning

Guest Editors:

Dr. Simon K. S. Cheung

Dr. Kam Cheong Li

Prof. Dr. Fu-Lee Wang

Prof. Dr. Harrison Hao Yang

Dr. Billy T. M. Wong

Deadline for manuscript
submissions:

closed (30 November 2023)

Message from the Guest Editors

Dear Colleagues,

Agile learning and blended learning are two emerging approaches to effective learning. The former focuses on flexibility, personalization and collaboration in the learning process, whereas the latter focuses on the integration of traditional learning with technologies such as e-learning, mobile learning, intelligent tutoring and learning analytics. With the common aims of enhancing learning effectiveness and enriching learning experience, agile learning and blended learning may complement each other to derive new methods and practices that benefit learners with diversified learning needs.

Agile blended learning is an attempt to integrate agile learning and blended learning with an aim to improve learning effectiveness and enrich learning experience, especially for learners with diversified learning needs. It best suits the learning needs of city-dwellers.

This Special Issue will focus on how the latest advances in technology can be effectively used in agile blended learning. We welcome the submission of original papers reporting novel applications of technology in agile learning, blended learning and their integration.





an Open Access Journal by MDPI

Editor-in-Chief

Prof. Dr. Flavio Canavero

Department of Electronics and
Telecommunications,
Politecnico di Torino, 10129
Torino, Italy

Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

Author Benefits

Open Access: free for readers, with [article processing charges \(APC\)](#) paid by authors or their institutions.

High Visibility: indexed within [Scopus](#), [SCIE \(Web of Science\)](#), [CAPus / SciFinder](#), [Inspec](#), [Ei Compendex](#) and [other databases](#).

Journal Rank: JCR - Q2 (Engineering, Electrical and Electronic) / CiteScore - Q1 (Electrical and Electronic Engineering)

Contact Us

Electronics Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland

Tel: +41 61 683 77 34
www.mdpi.com

mdpi.com/journal/electronics
electronics@mdpi.com
[X@electronicsMDPI](https://twitter.com/electronicsMDPI)